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(12) **United States Design Patent**  
**Alfredsson et al.**

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(54) **ELECTRONIC DEVICE HOUSING**

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(73) Assignee: **ABB Schweiz AG**, Baden (CH)  
(\*\*) Term: **15 Years**  
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Apr. 5, 2019 (EM) ..... 006370771

(51) **LOC (13) Cl.** ..... **13-03**  
(52) **U.S. Cl.**  
USPC ..... **D13/184**; D13/110; D13/123  
(58) **Field of Classification Search**  
USPC ..... D13/110, 123, 158, 162, 184, 199;  
D14/301, 439

(Continued)

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(74) *Attorney, Agent, or Firm* — Slater Matsil, LLP

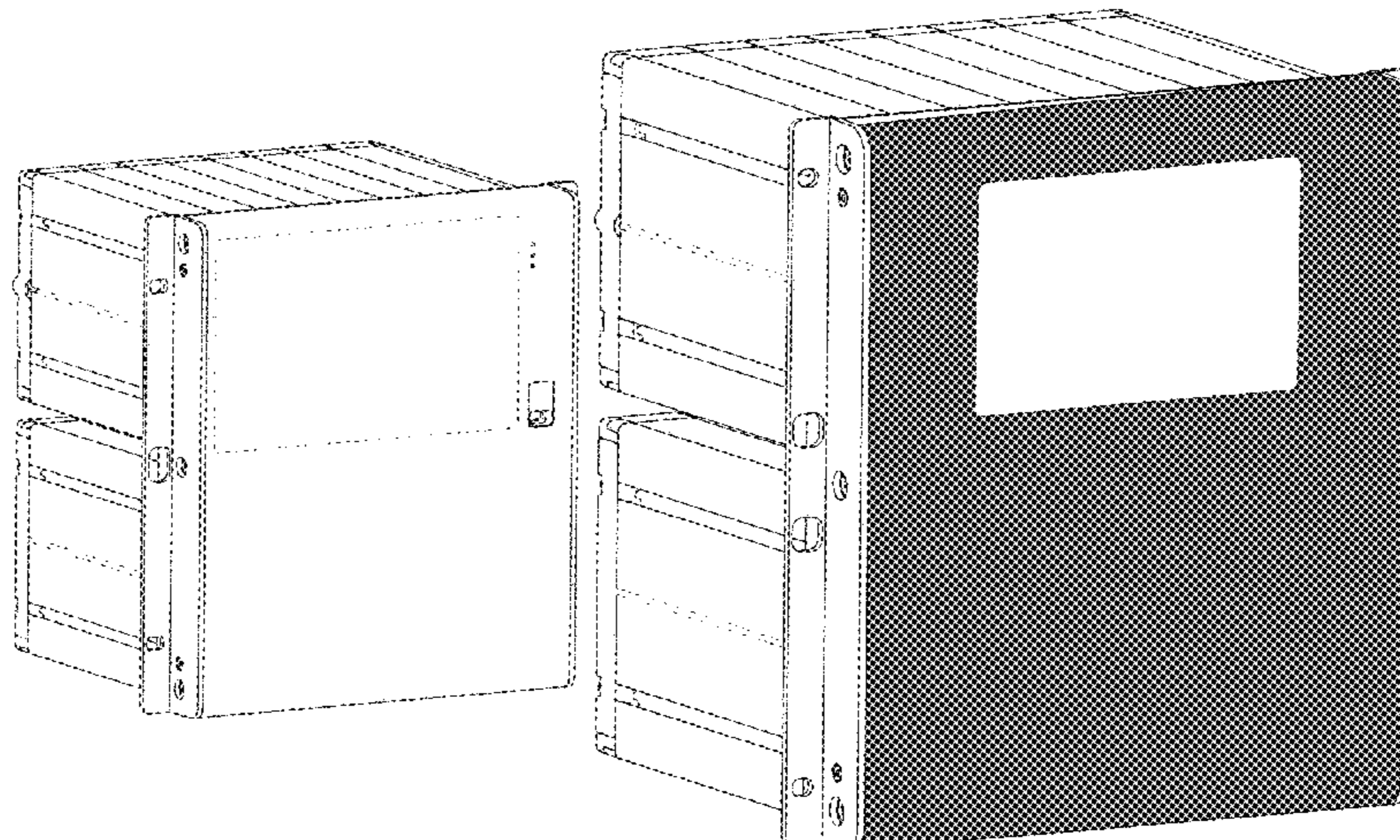
(57) **CLAIM**

The ornamental design for a electronic device housing, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, front isometric view of a first embodiment of a electronic device housing in accordance with-the new design;  
FIG. 2 is a left side elevational view of the embodiment shown in FIG. 1;  
FIG. 3 is a right side elevational view of the embodiment shown in FIG. 1;  
FIG. 4 is a front elevational view of the embodiment shown in FIG. 1;  
FIG. 5 is a rear elevational view of the embodiment shown in FIG. 1;  
FIG. 6 is a top plan view of the embodiment shown in FIG. 1;  
FIG. 7 is a bottom plan view of the embodiment shown in FIG. 1;  
FIG. 8 is a top, front isometric view of a second embodiment of the electronic device housing in accordance with the new design;  
FIG. 9 is a left side elevational view of the embodiment shown in FIG. 8;  
FIG. 10 is a right side elevational view of the embodiment shown in FIG. 8;  
FIG. 11 is a front elevational view of the embodiment shown in FIG. 8;  
FIG. 12 is a rear elevational view of the embodiment shown in FIG. 8;  
FIG. 13 is a top plan view of the embodiment shown in FIG. 8; and,  
FIG. 14 is a bottom plan view of the embodiment shown in FIG. 8.  
The broken line portions of the figure drawings are included to show unclaimed subject matter only and form no part of the claimed design.  
The dash-dot broken lines define the bounds of the claimed design and form no part thereof.

**1 Claim, 14 Drawing Sheets**



(58) **Field of Classification Search**

CPC ..... G05B 9/02; G05B 19/05; G05B 19/054;  
 G05B 19/056; G06F 1/182; G06F 1/183;  
 G06F 1/26; H05K 7/1462; H05K 7/1467;  
 H05K 7/1474; H05K 7/1432; H02B 1/26;  
 H02B 1/30; H02B 1/305

See application file for complete search history.

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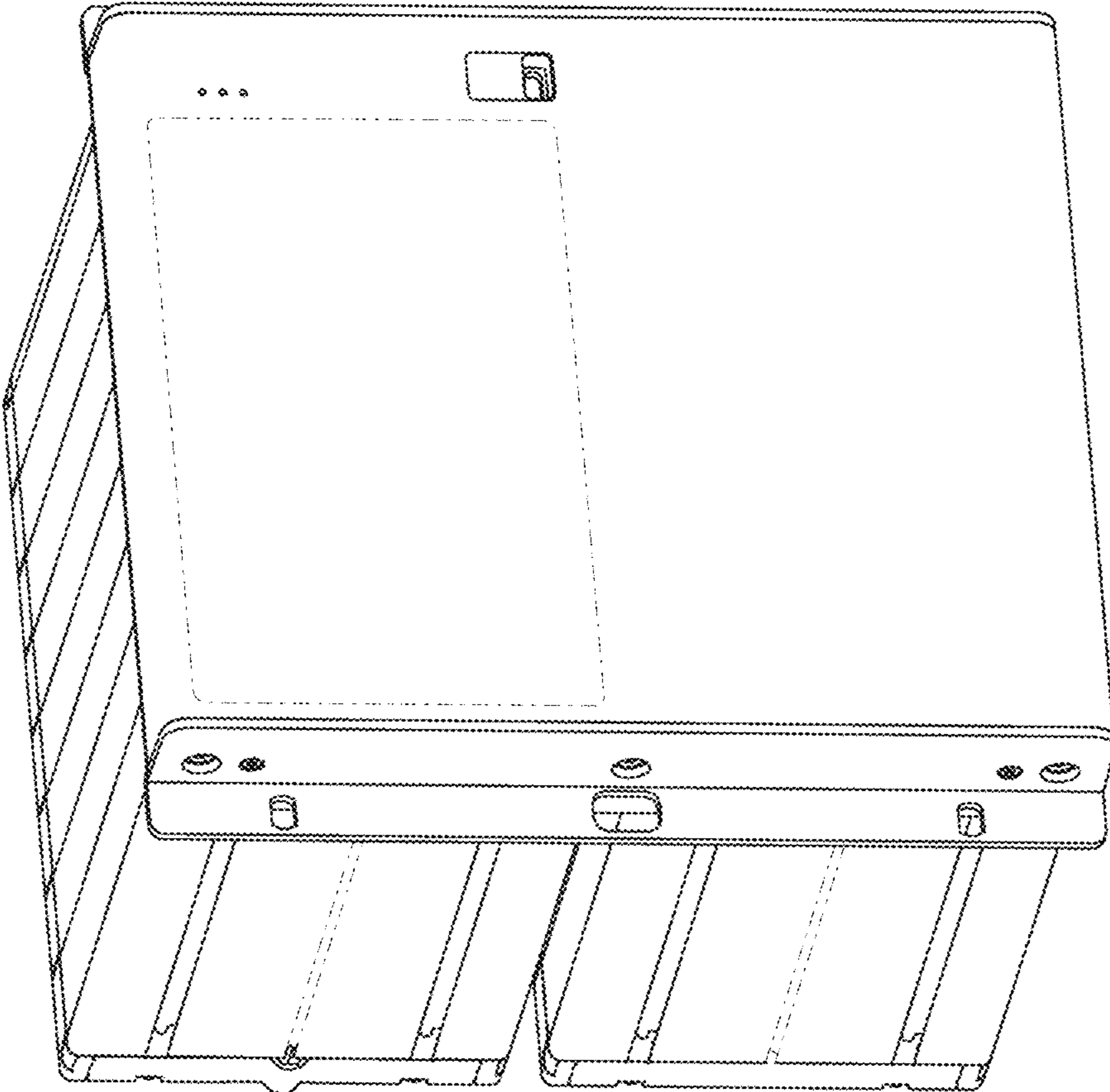


FIG. 1

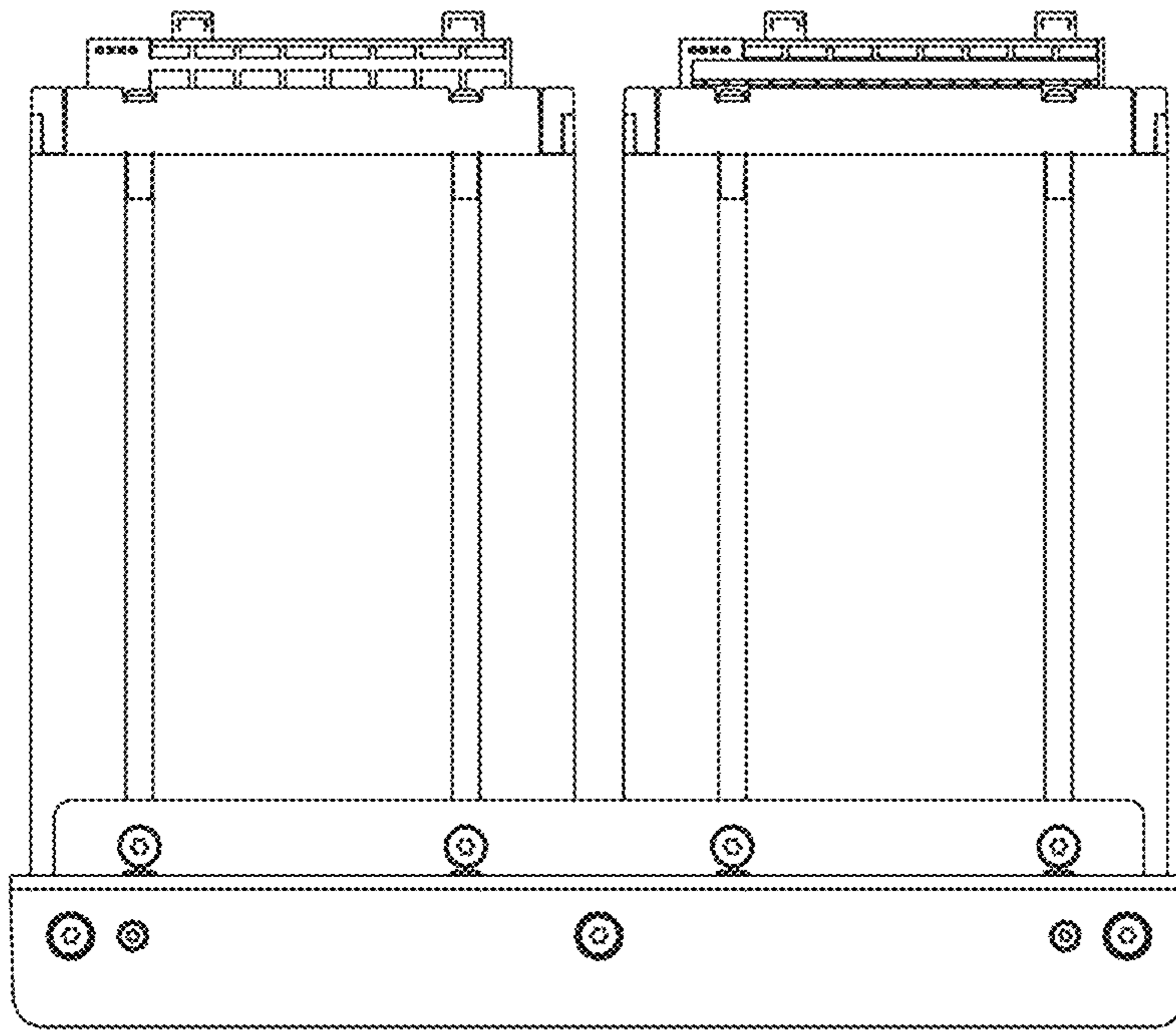


FIG. 2



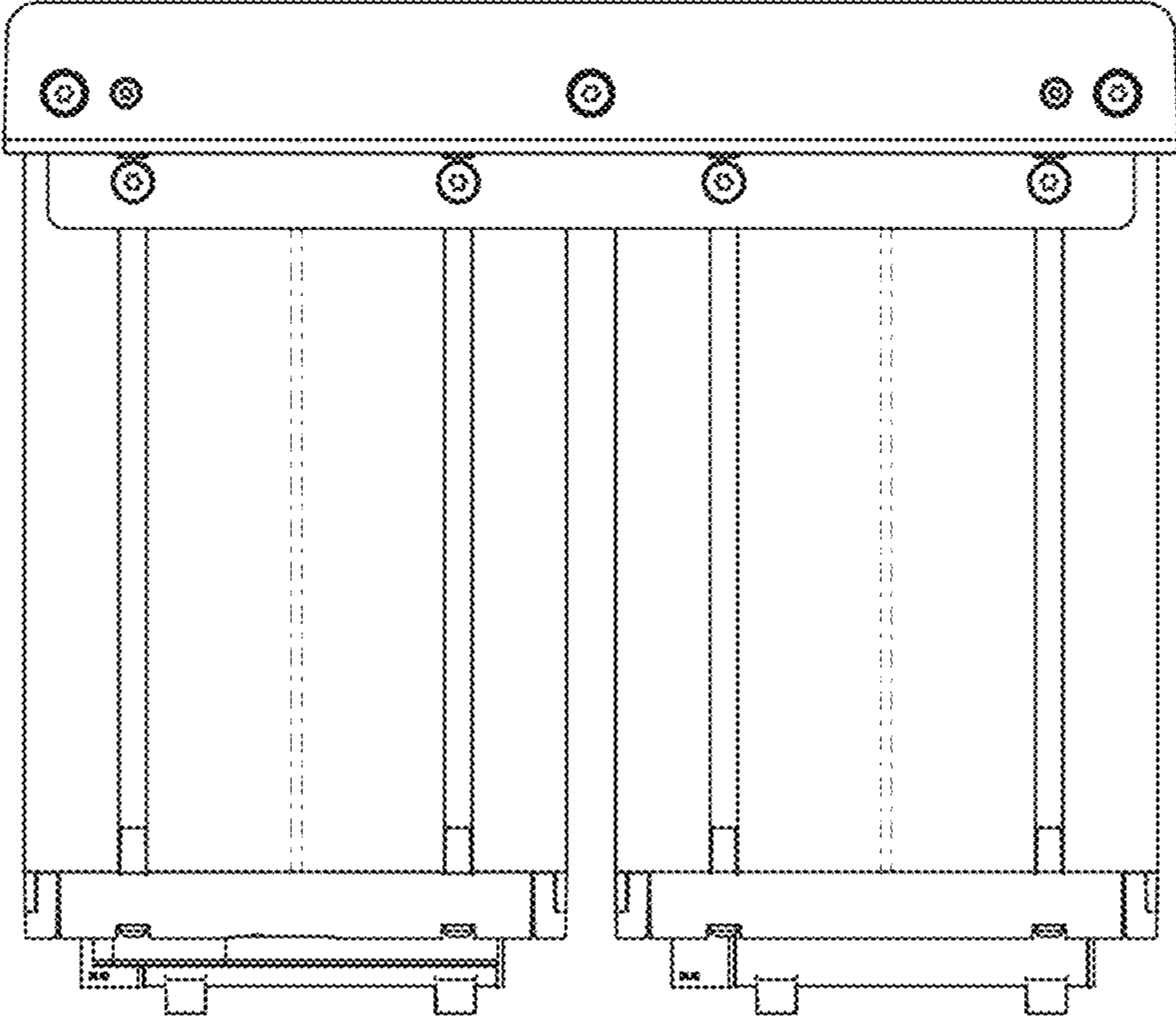


FIG. 3

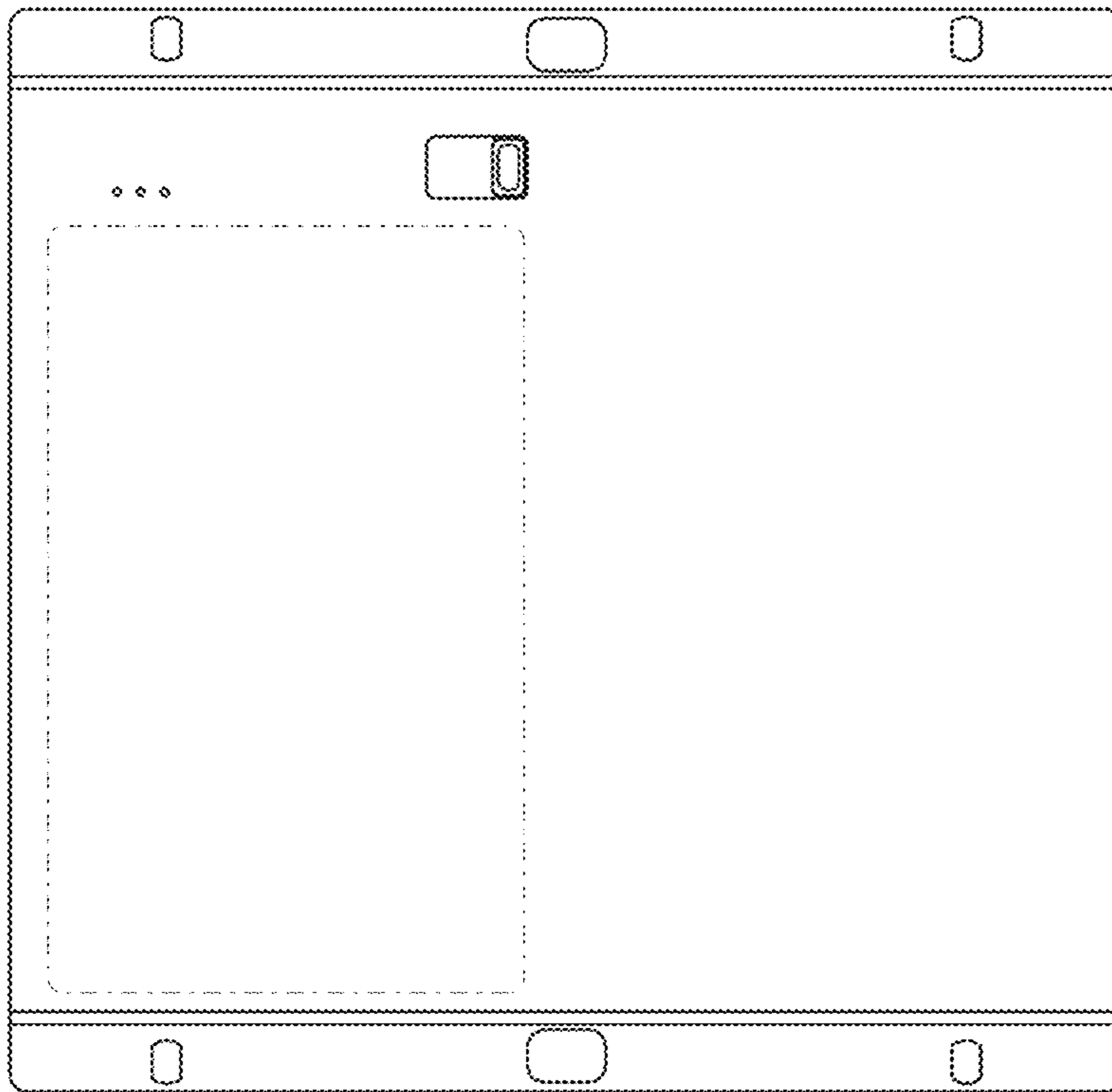


FIG. 4

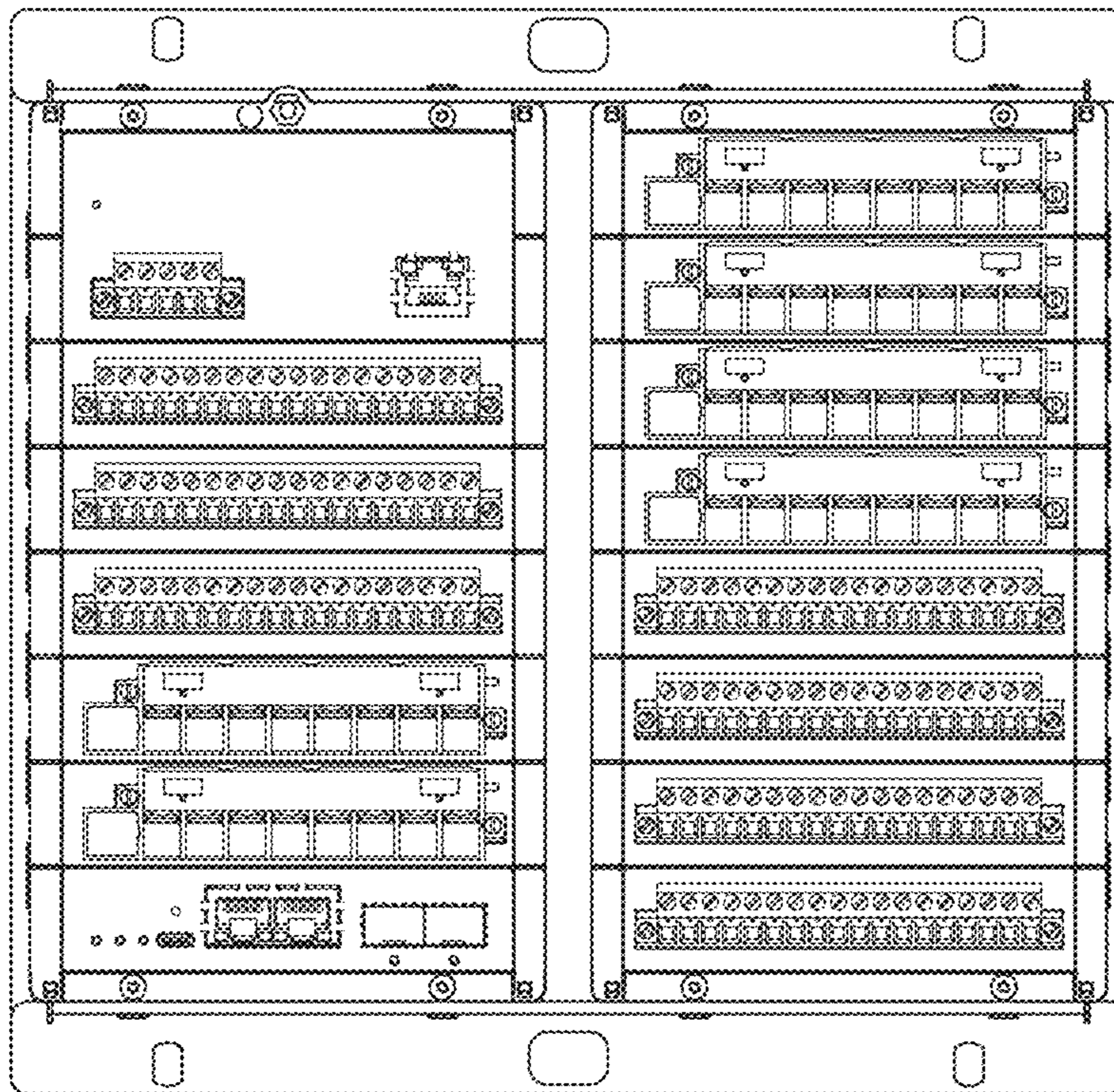


FIG. 5

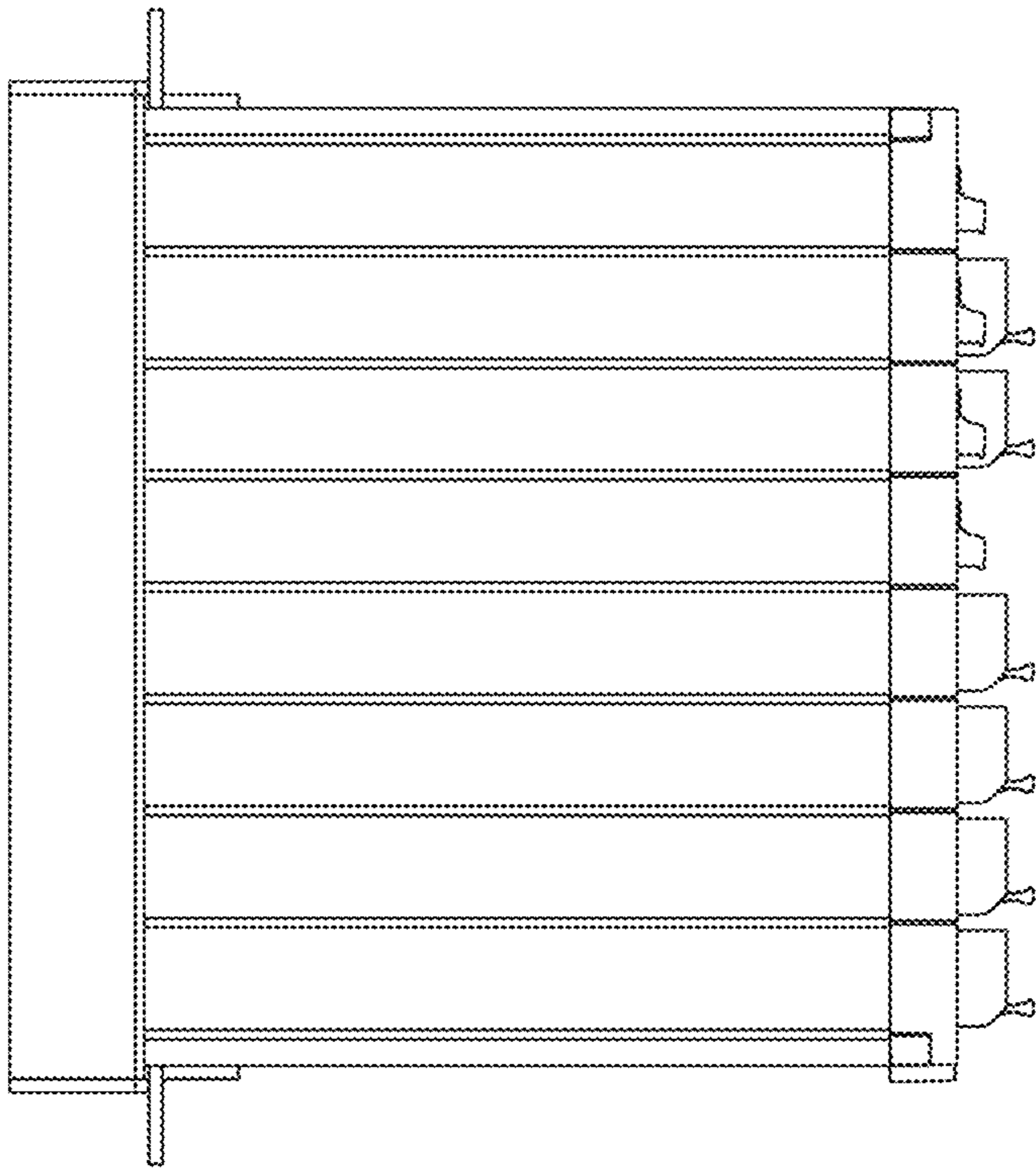


FIG. 6



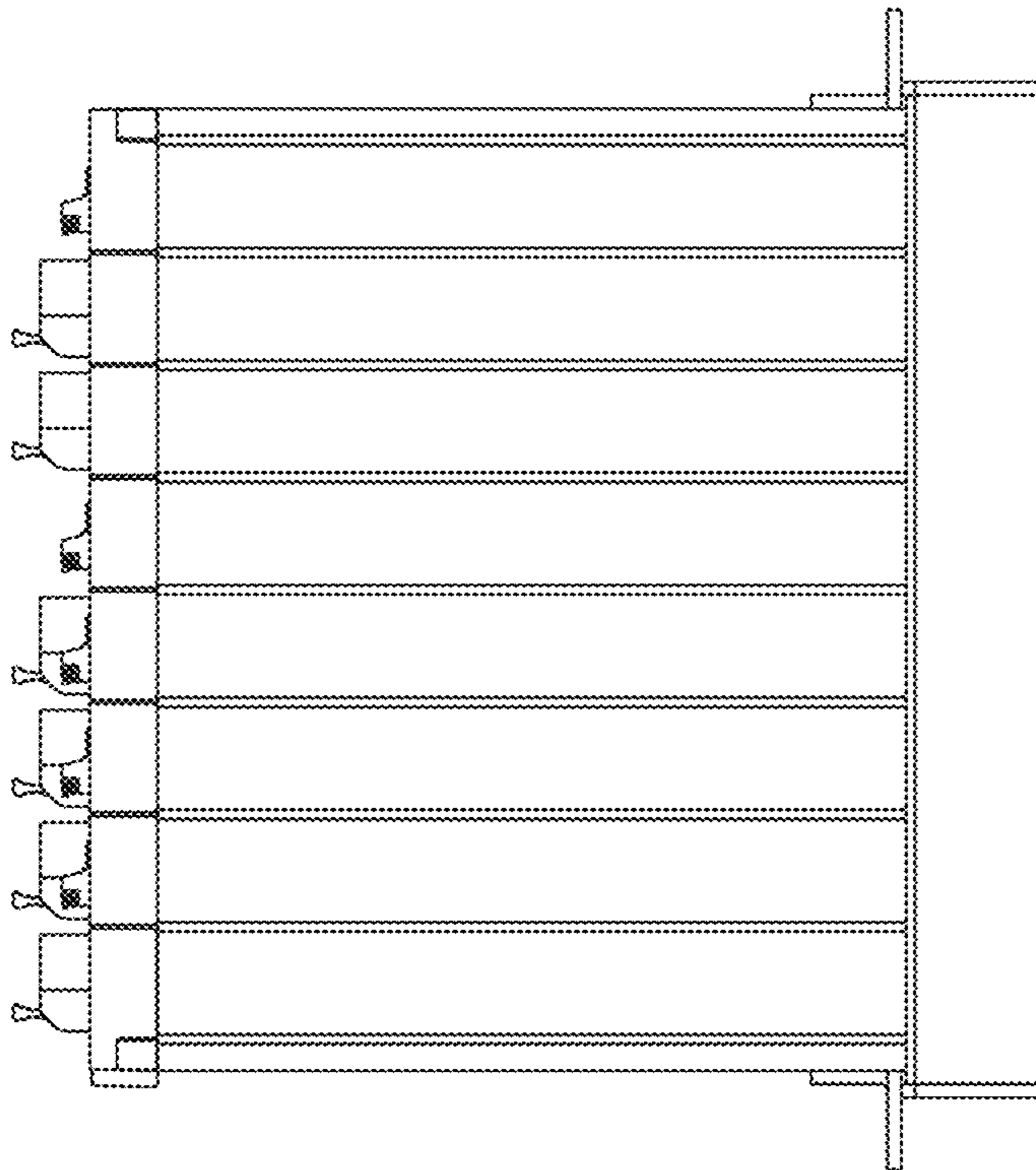


FIG. 7

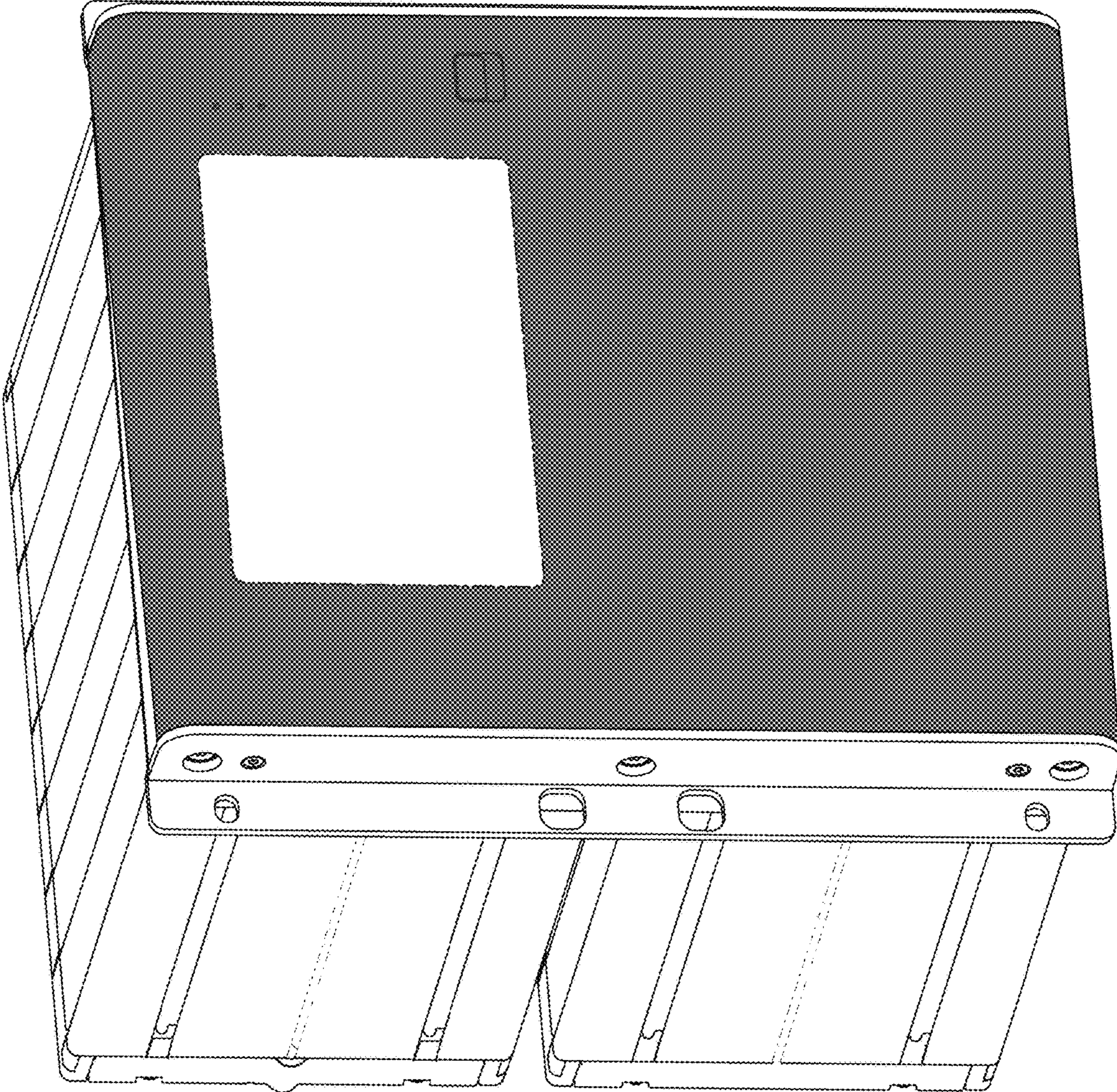


FIG. 8



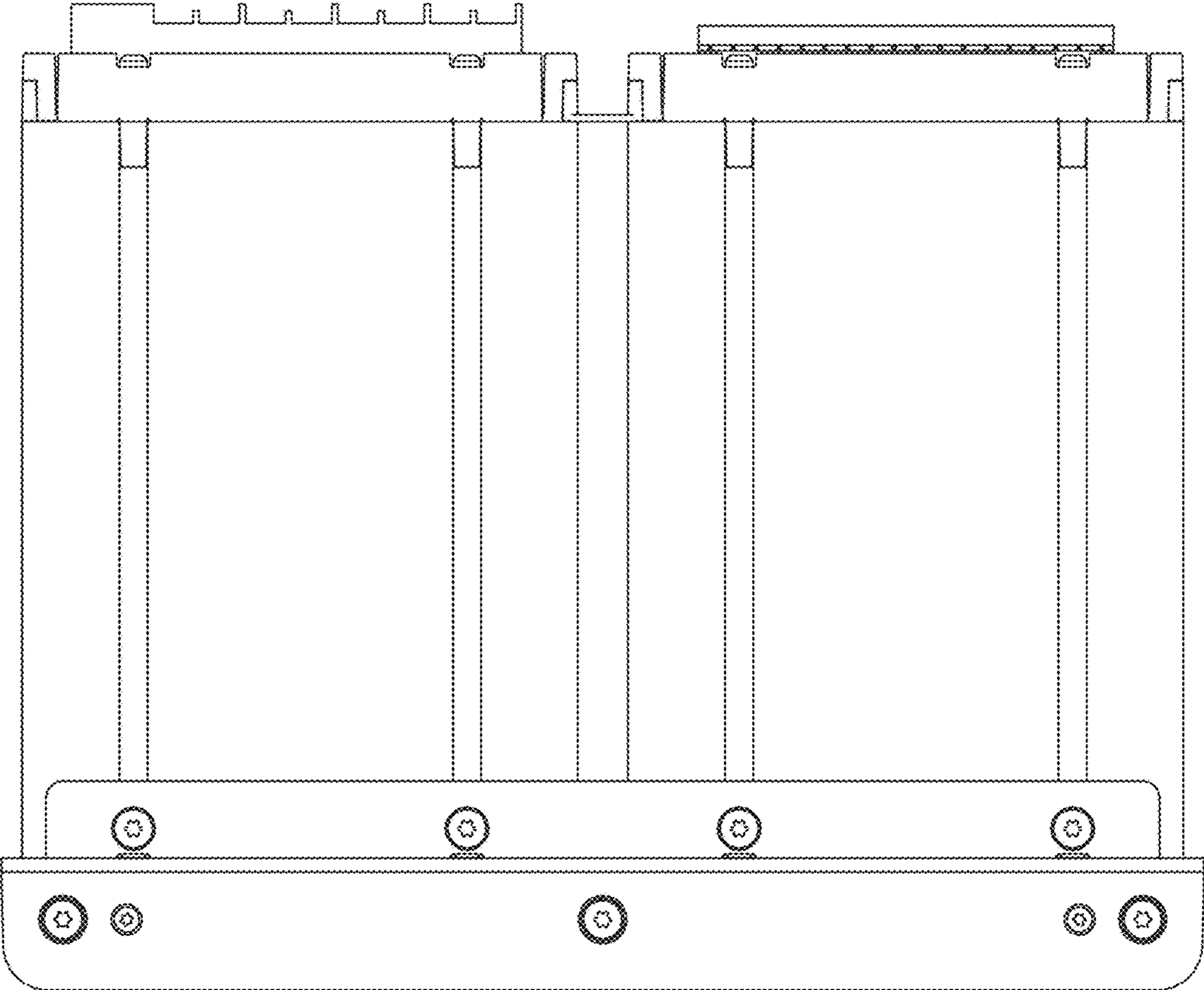


FIG. 9

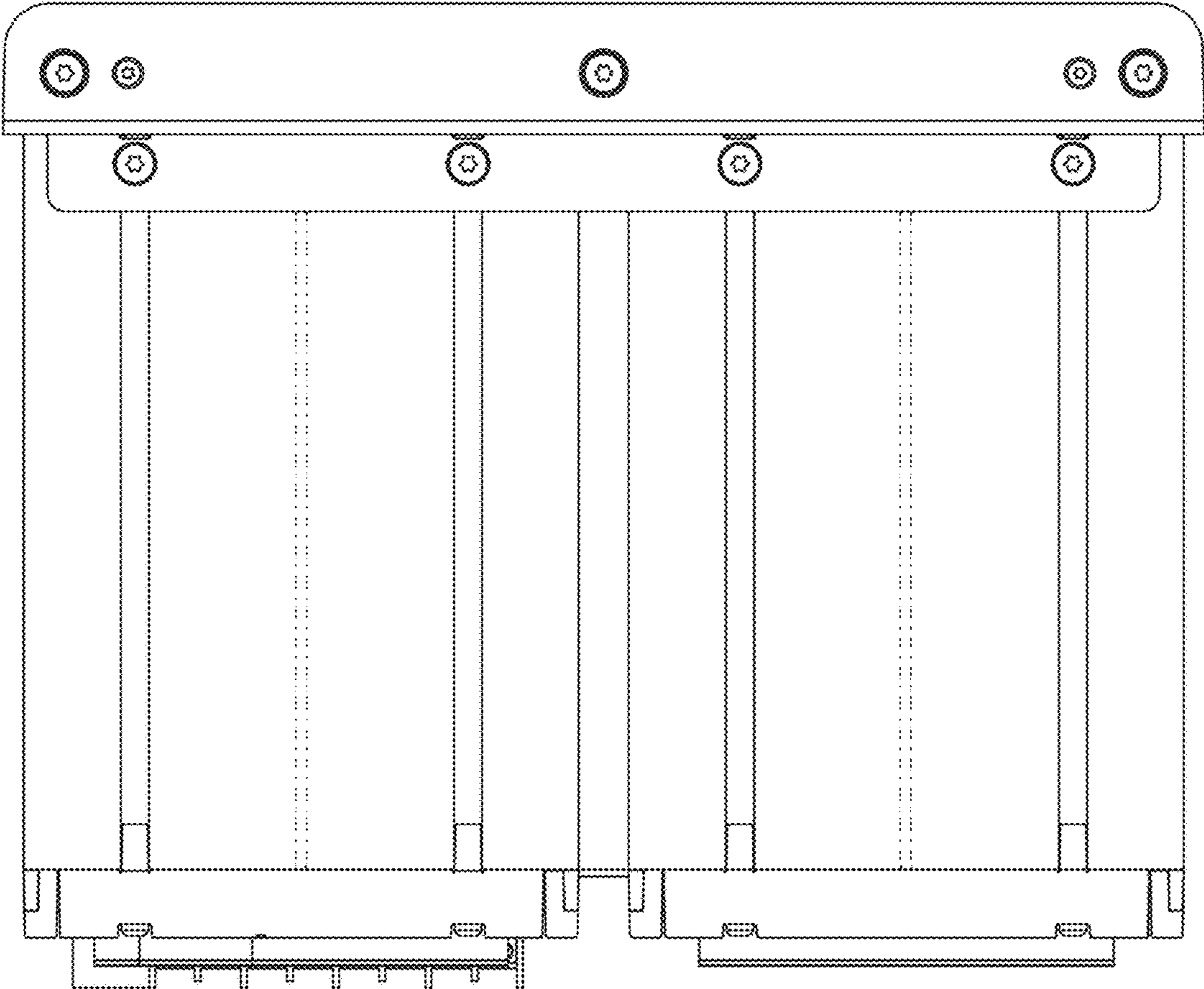


FIG. 10



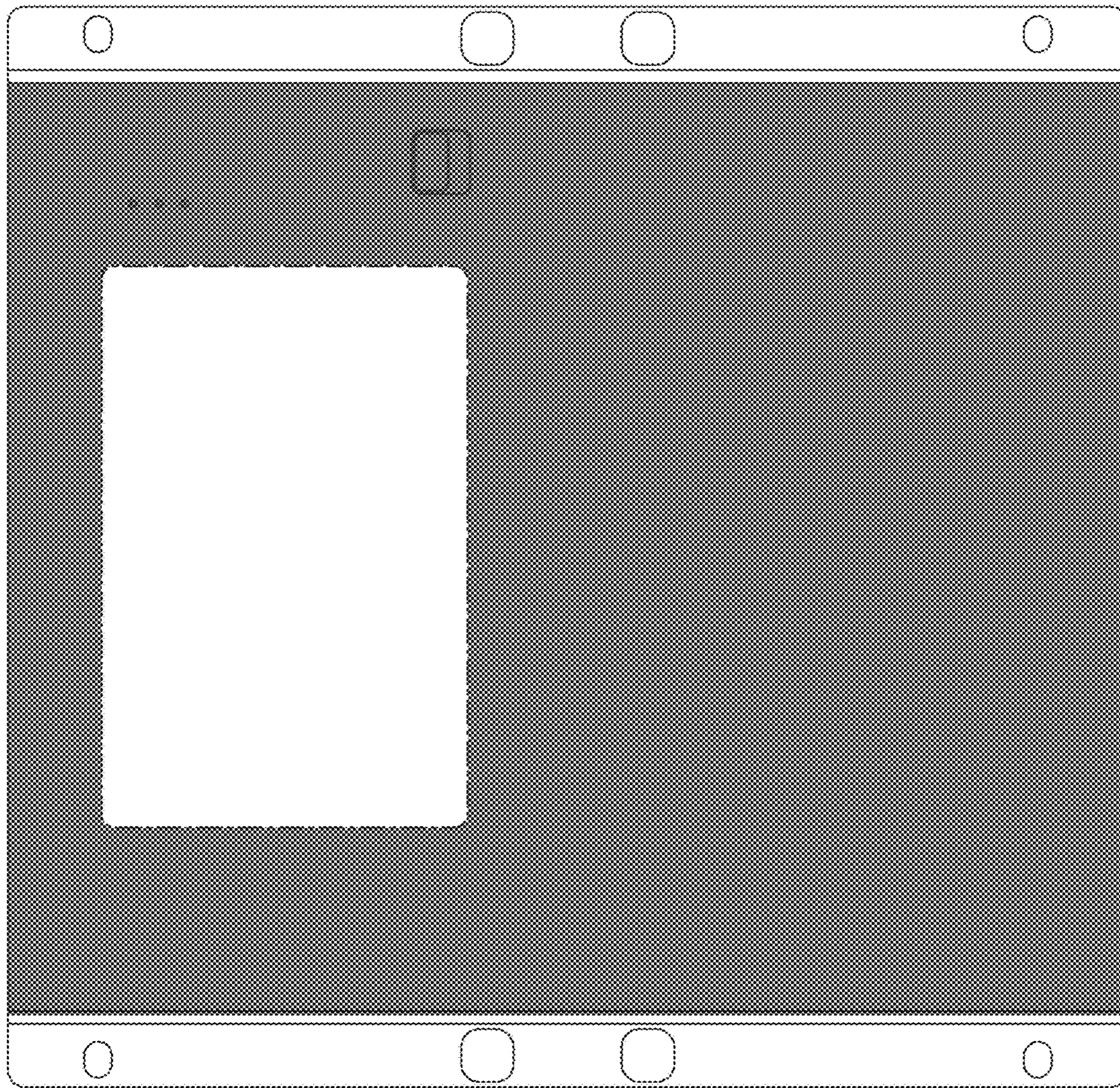


FIG. 11



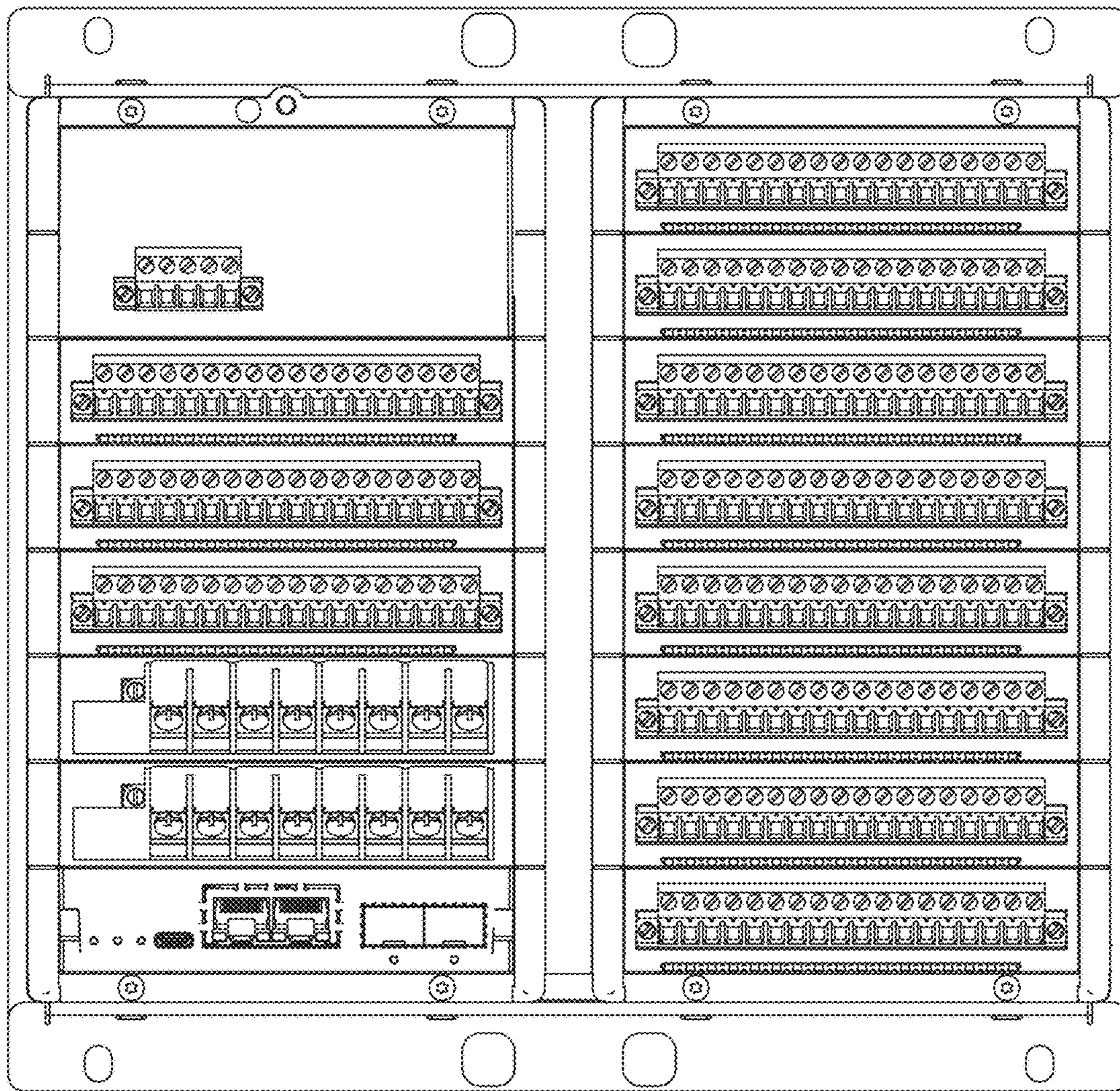


FIG. 12

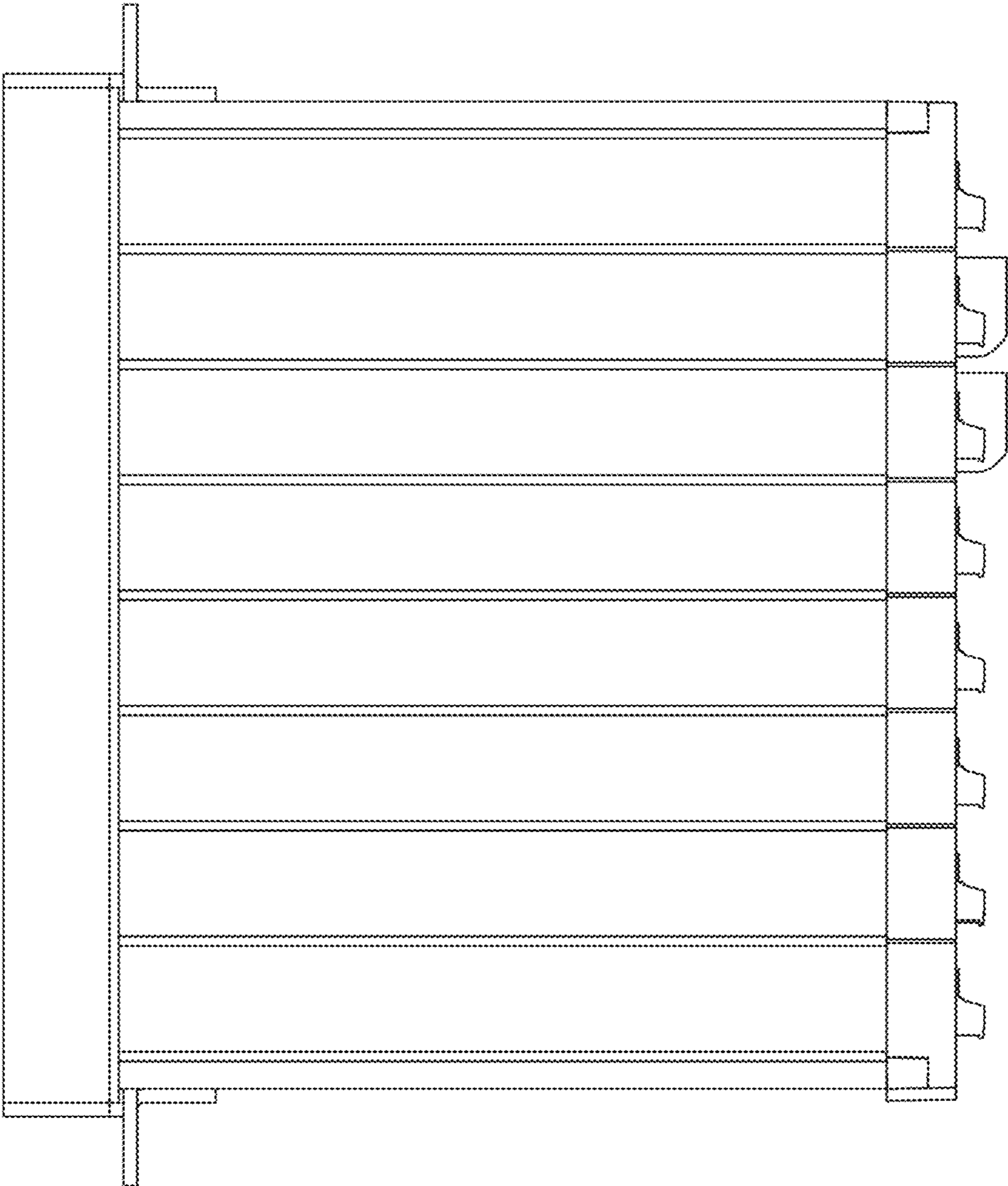


FIG. 13

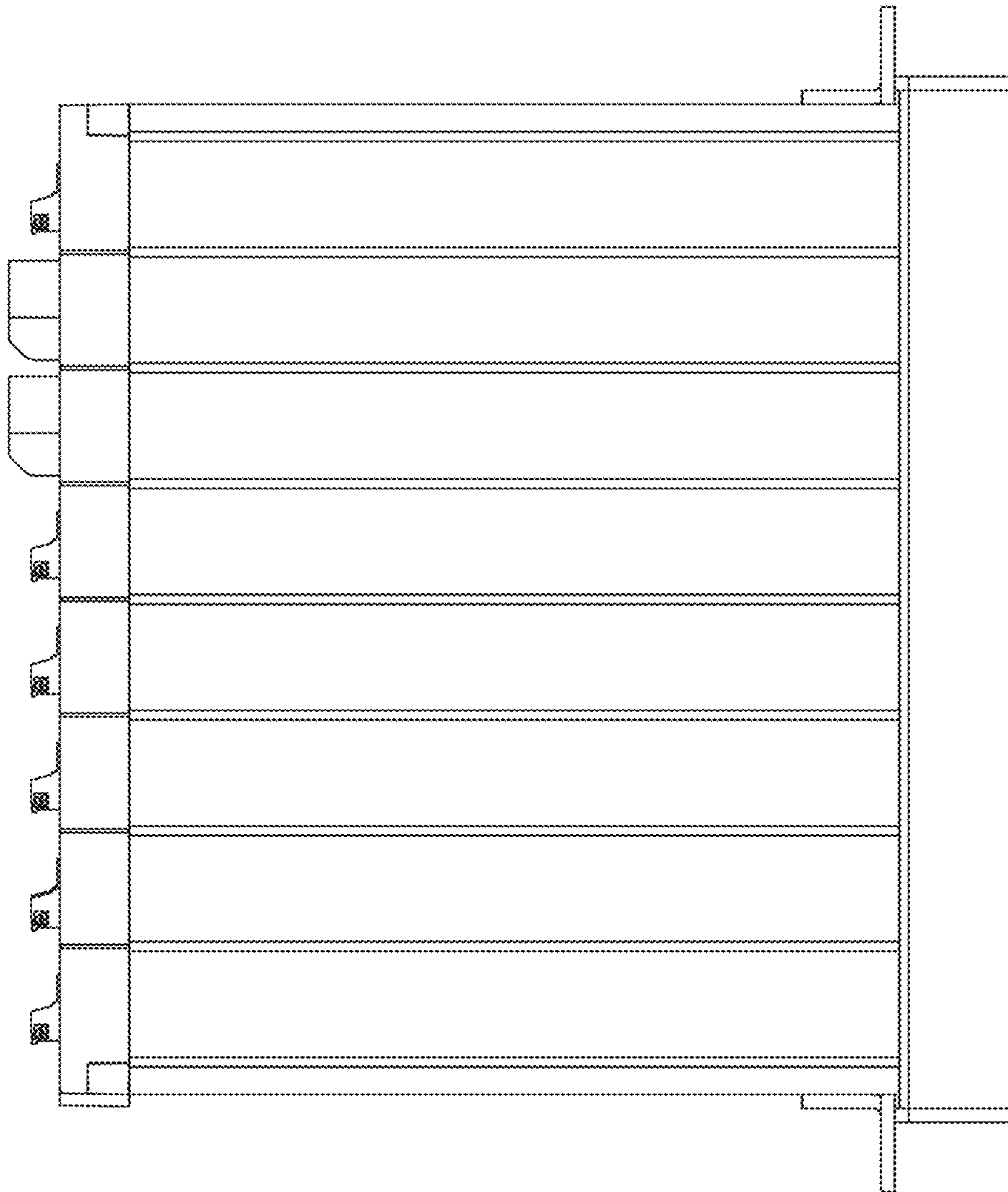


FIG. 14